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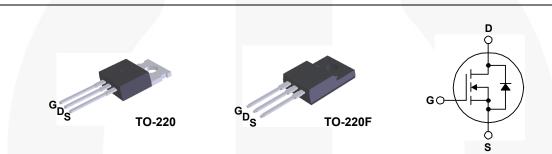
FQP13N50C / FQPF13N50C N-Channel QFET[®] MOSFET 500 V, 13 A, 480 mΩ

Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize onstate resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction, electronic lamp bridge topology.

Features

- 13 A, 500 V, $R_{DS(on)}$ = 480 m Ω (Max.) @ V_{GS} = 10 V, I_{D} = 6.5 A
- Low Gate Charge (Typ. 43 nC)
- Low Crss (Typ. 20 pF)
- 100% Avalanche Tested



Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

Symbol	Parameter	FQP13N50C	FQPF13N50C	Units	
V _{DSS}	Drain-Source Voltage	5	V		
I _D	Drain Current - Continuous (T _C = 25°	°C)	13	13 *	А
	- Continuous (T _C = 100)°C)	8	8 *	А
I _{DM}	Drain Current - Pulsed	(Note 1)	52	52 *	А
V _{GSS}	Gate-Source Voltage	± 30		V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	860		mJ
I _{AR}	Avalanche Current	(Note 1)	13		А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	19.5		mJ
dv/dt	Peak Diode Recovery dv/dt	4.5		V/ns	
PD	Power Dissipation ($T_C = 25^{\circ}C$)	195	48	W	
	- Derate above 25°C	1.56	0.39	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Ran	-55 to +150		°C	
TL	Maximum lead temperature for soldering	300		°C	
۲L	1/8" from case for 5 seconds				

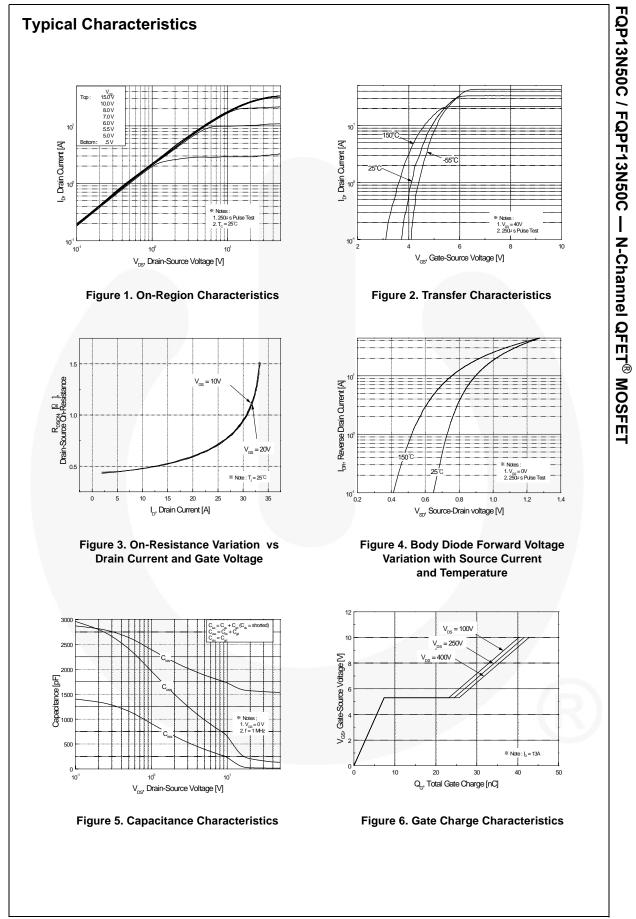
* Drain current limited by maximum junction temperature

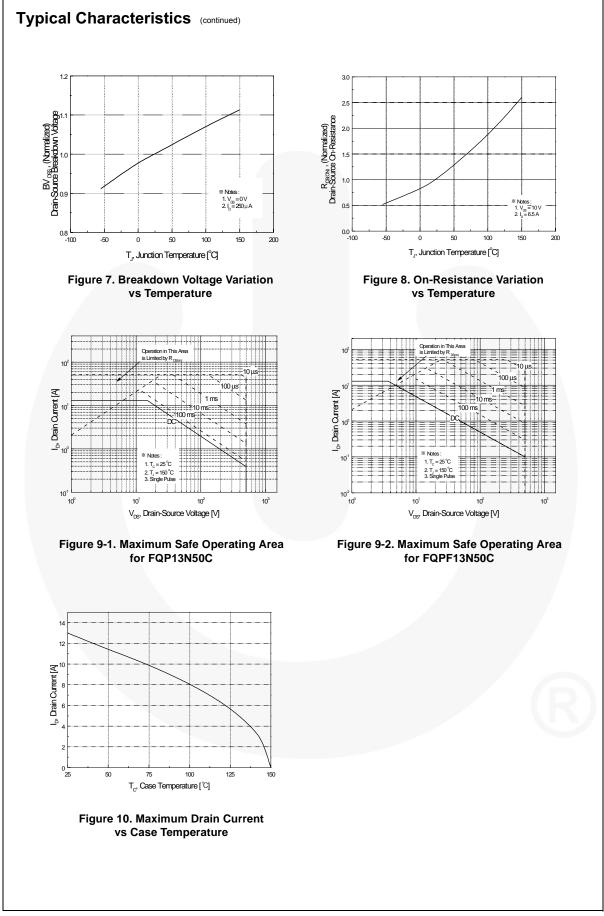
Thermal Characteristics

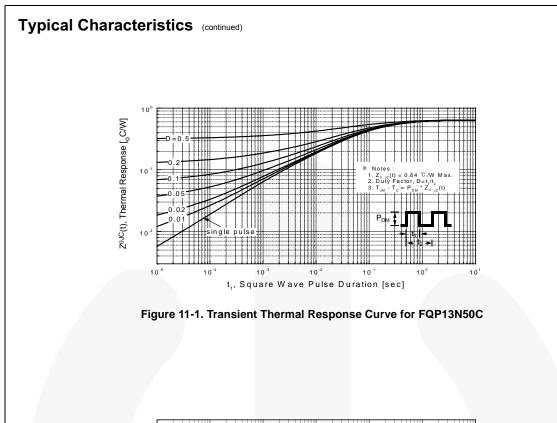
Symbol	Parameter	FQP13N50C	FQPF13N50C	Units	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.64	2.58	°C/W	
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5		°C/W	
R _{0JA} Thermal Resistance, Junction-to-Ambient, Max.		62.5	62.5	°C/W	

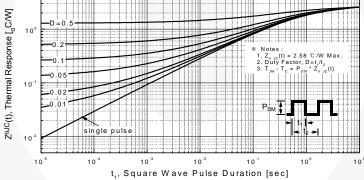
November 2013

Part Number Top Mark Pack FQP13N50C_F105 FQP13N50C TO-2 FQPF13N50C_F105 FQPF13N50C TO-2		Top Mark Pack		age Packing Method Reel S		Size	Tape Width		Quantity	
		FQP13N50C	TO-2	-220 Tube N		A	N/A		50 units	
		220F Tube N/			A	N/A		50 units		
Electri	cal Cha	racteristics т ,	_c = 25°C un	less otherv	vise noted.					
Symbol		Parameter			Test Conditions		Min	Тур	Max	Unit
Off Cha	aracteristi	cs								
BV _{DSS}	Drain-Sour	rce Breakdown Volta	ige	V _{GS} =	0 V, I _D = 250 μA		500			V
ΔBV _{DSS} / ΔT _J	Breakdowr Coefficient	n Voltage Temperatu	re	$I_D = 250 \ \mu$ A, Referenced to 25°C				0.5		V/°C
I _{DSS}			nt	$V_{DS} = 500 V, V_{GS} = 0 V$ $V_{DS} = 400 V, T_C = 125^{\circ}C$					1	μA
	Zero Gale	ero Gate Voltage Drain Current							10	μA
I _{GSSF}		Leakage Current, F		V_{GS} = 30 V, V_{DS} = 0 V					100	nA
I _{GSSR}	Gate-Body	Leakage Current, F	Reverse	V _{GS} =	-30 V, V _{DS} = 0 V				-100	nA
On Cha	racteristi	cs								
V _{GS(th)}		shold Voltage		V _{DS} =	V _{GS} , I _D = 250 μA		2.0		4.0	V
R _{DS(on)}	Static Drai On-Resista			V _{GS} =	10 V, I _D = 6.5 A			0.39	0.48	Ω
9 _{FS}	Forward Tr	ransconductance	_	V _{DS} =	40 V, I _D = 6.5 A			15		S
Dynami	ic Charac	teristics								
C _{iss}	Input Capa	acitance		V _{DS} =	V _{DS} = 25 V, V _{GS} = 0 V,			1580	2055	pF
C _{oss}	Output Ca			f = 1.0	MHz			180	235	pF
C _{rss}	Reverse T	ransfer Capacitance						20	25	pF
Switchi	ing Chara	cteristics								
t _{d(on)}	-	Delay Time		$V_{} = 250 V_{} = 13 A_{}$			25	60	ns	
t _r	Turn-On R	ise Time		$V_{DD} = 250 \text{ V}, \text{ I}_{D} = 13 \text{ A},$			100	210	ns	
t _{d(off)}	Turn-Off D	elay Time		ING 2	R _G = 25 Ω			130	270	ns
t _f	Turn-Off Fa	all Time				(Note 4)		100	210	ns
Qg	Total Gate	Charge		V _{DS} = 400 V, I _D = 13 A, V _{GS} = 10 V				43	56	nC
Q _{gs}	Gate-Sour	ce Charge						7.5		nC
Q _{gd}	Gate-Drain	n Charge		(Note 4)				18.5		nC
		ada Chavaatavid	4:	od Mos	dimum Datin va					
Drain-S	T	ode Characteris Continuous Drain-So			•	•			13	Α
I _{SM}		1aximum Pulsed Drain-Source Diode F							52	A
V _{SD}	Drain-Sour	ce Diode Forward V	oltage	V_{GS} = 0 V, I _S = 13 A			/	1.4	V	
t _{rr}		ecovery Time	0 -	$V_{GS} = 0 V, I_S = 13 A,$				410		ns
Q _{rr}		ecovery Charge			t = 100 A/μs			4.5		μC
		, ,								

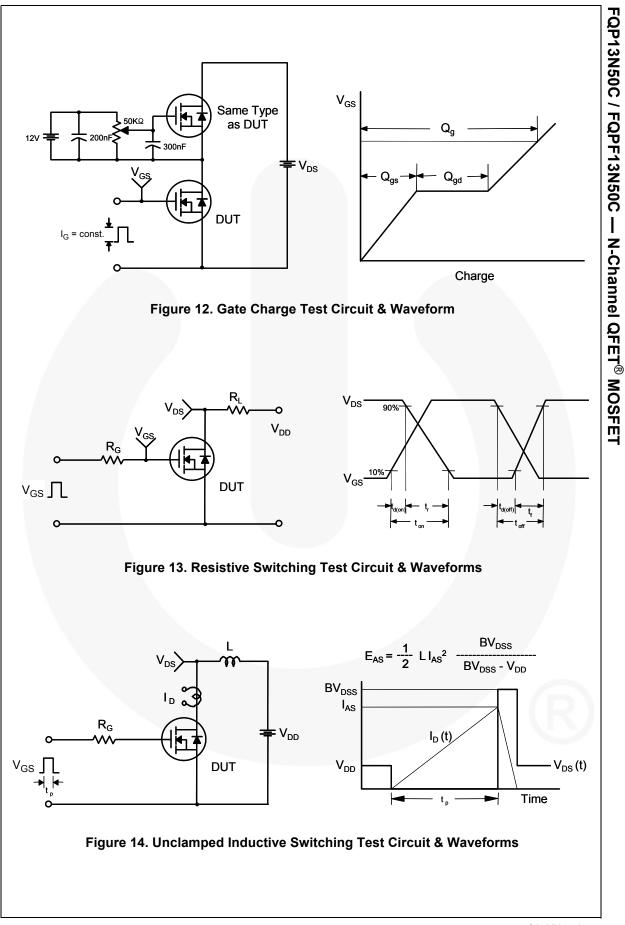


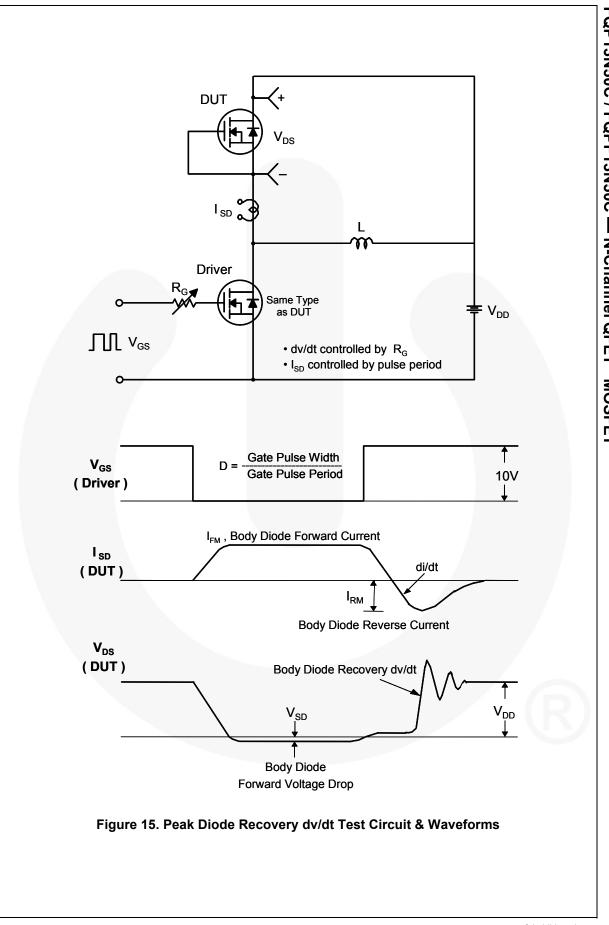


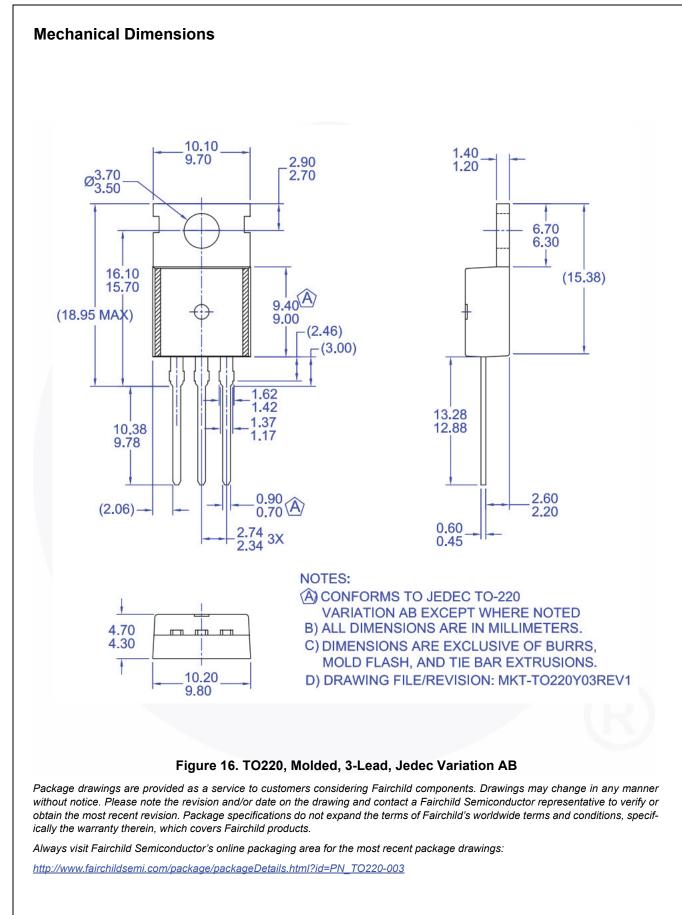


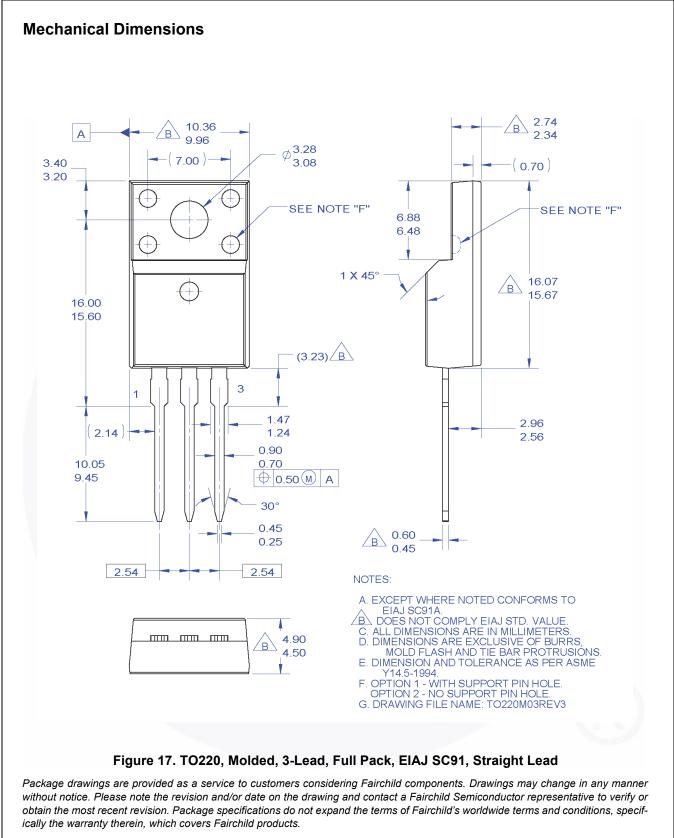












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FQP13N50C / FQPF13N50C

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N-Channel QFET[®] MOSFET



Datasheet Identification Product Status		Definition				
Advance Information Formative / In Design		Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.				
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.				
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